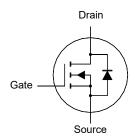
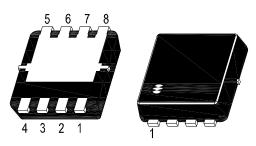
N-Channel Enhancement Mode MOSFET

Features

- AEC-Q101 Qualified
- Surface-mounted package
- Halogen and Antimony Free(HAF), RoHS compliant





 Source 2. Source 3. Source 4. Gate
 Drain 6. Drain 7. Drain 8. Drain DFN3030 Plastic Package

Applications

• synchronous buck converter

Key Parameters

Parameter	Value	Unit					
BV _{DSS}	40	V					
P May	6.5 @ V _{GS} = 10 V	mΩ					
R _{DS(ON)} Max	9 @ V _{GS} = 4.5 V	11122					
V _{GS(th)} typ	1.4	V					
Q _g typ	59 @ V _{GS} = 10 V	nC					

Absolute Maximum Ratings(at T_a = 25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	40	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current - Continuous $T_c = 25^{\circ}C$ $T_c = 100^{\circ}C$, I _D	40 31	Α
Peak Drain Current, Pulsed 1)	I _{DM}	140	Α
Single-Pulse Avalanche Current	I _{AS}	32.9	Α
Single-Pulse Avalanche Energy 2)	E _{AS}	54.1	mJ
Power Dissipation T _c = 25°C	P _D	36.7	W
Operating Junction and Storage Temperature Range	T _j , T _{stg}	- 55 to + 150	°C

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Case	$R_{ heta JC}$	3.4	°C/W
Thermal Resistance from Junction to Ambient 3)	$R_{ hetaJA}$	75	°C/W

¹⁾ Pulse Test: Pulse Width ≤ 100 μs, Duty Cycle ≤ 2%, Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ = 150°C.

³⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air.



 $^{^{2)}}$ Limited by $T_{J(MAX)},$ starting T_J = 25 °C, L = 0.1 mH, R_g = 25 $\Omega,$ I_D = 32.9 A, V_{GS} = 10 V.

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Characteristics at T_a = 25°C unless otherwise specified

Parameter	Symbol	Min.	Тур.	Max.	Unit
STATIC PARAMETERS					
Drain-Source Breakdown Voltage at $I_D = 250 \mu A$	BV _{DSS}	40	-	-	V
Drain-Source Leakage Current at V_{DS} = 32 V	I _{DSS}	-	-	1	μΑ
Gate-Source Leakage Current at $V_{GS} = \pm 20 \text{ V}$	I _{GSS}	-	-	± 100	nA
Gate-Source Threshold Voltage at V_{DS} = V_{GS} , I_D = 250 μA	$V_{GS(th)}$	1	-	2.5	V
Drain-Source On-State Resistance at V_{GS} = 10 V, I_D = 10 A at V_{GS} = 4.5 V, I_D = 5 A	R _{DS(on)}	-	5.1 -	6.5 9	mΩ
DYNAMIC PARAMETERS					
Forward Transconductance at $V_{DS} = 5 \text{ V}$, $I_D = 5 \text{ A}$	g fs	-	27	-	S
Gate Resistance at $V_{GS} = 0 \text{ V}$, $V_{DS} = 0 \text{ V}$, $f = 1 \text{ MHz}$	R_g	-	0.4	-	Ω
Input Capacitance at $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C _{iss}	-	3303	-	pF
Output Capacitance at $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C _{oss}	-	223	-	pF
Reverse Transfer Capacitance at $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C _{rss}	-	196	-	pF
Gate Charge Total at V_{DS} = 20 V, V_{GS} = 10 V, I_D = 10 A at V_{DS} = 20 V, V_{GS} = 4.5 V, I_D = 10 A	Qg		59 29	- -	nC
Gate to Source Charge at V_{DS} = 20 V, V_{GS} = 10 V, I_D = 10 A	Q_{gs}	-	7.6	-	nC
Gate to Drain Charge at V_{DS} = 20 V, V_{GS} = 10 V, I_{D} = 10 A	Q_{gd}	-	10.2	-	nC
Turn-On Delay Time at V_{GS} = 10 V, V_{DS} = 15 V, I_D = 1 A, R_g = 3.3 Ω	t _{d(on)}	-	15.2	-	ns
Turn-On Rise Time at V_{GS} = 10 V, V_{DS} = 15 V, I_D = 1 A, R_g = 3.3 Ω	t _r	-	8.8	-	ns
Turn-Off Delay Time at V_{GS} = 10 V, V_{DS} = 15 V, I_D = 1 A, R_g = 3.3 Ω	$t_{d(off)}$	-	74	-	ns
Turn-Off Fall Time at V_{GS} = 10 V, V_{DS} = 15 V, I_D = 1 A, R_g = 3.3 Ω	t _f	-	7	-	ns
Body-Diode PARAMETERS					
Drain-Source Diode Forward Voltage at $I_S = 1$ A, $V_{GS} = 0$ V	V _{SD}	1	-	1	V
Body-Diode Continuous Current	I _S	-	-	40	Α
Body-Diode Continuous Current, Pulsed	I _{SM}	-	-	140	Α



Electrical Characteristics Curves

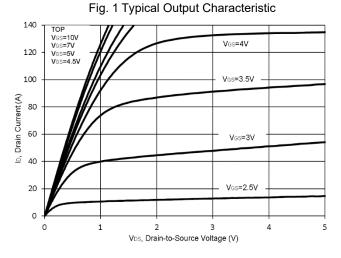


Fig. 2 Typical Transfer Characteristic

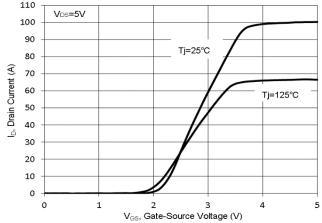


Fig. 3 on-Resistance vs. Gate Voltage

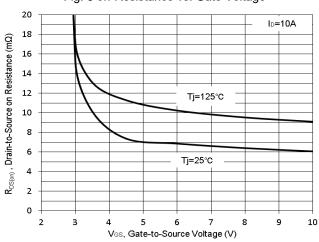


Fig. 4 on-Resistance vs.T_i

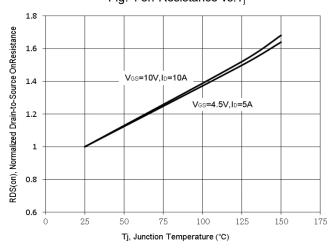


Fig. 5 on-Resistance vs. Drain Current

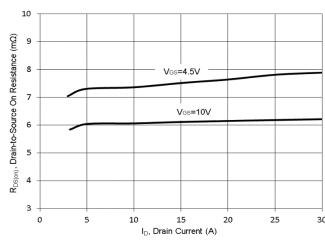
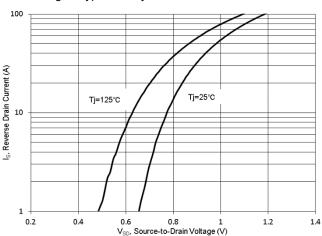
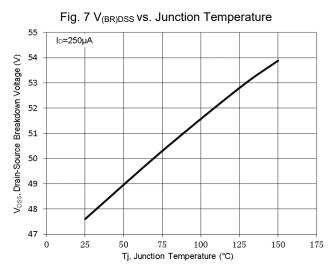


Fig. 6 Typical Body-Diode Forward Characteristic



Electrical Characteristics Curves



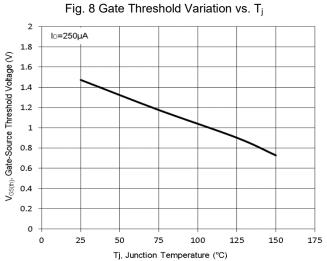


Fig. 9 Typical Junction Capacitance

Ciss

Ciss

Coss

Crss

Coss

Crss

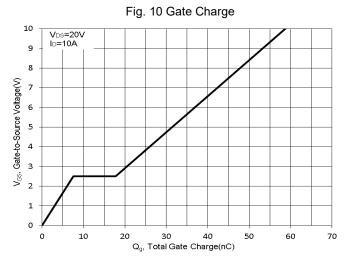
Coss

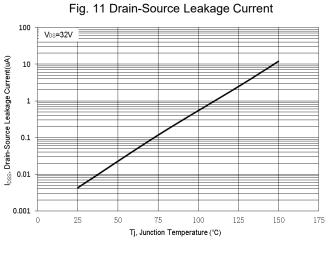
Crss

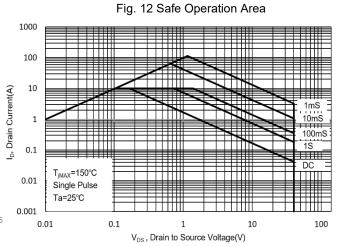
Coss

Crss

Coss

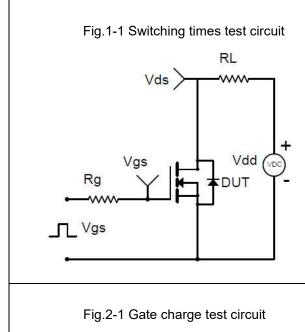


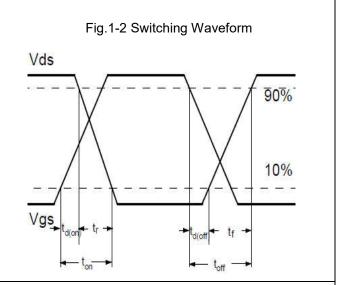




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Test Circuits





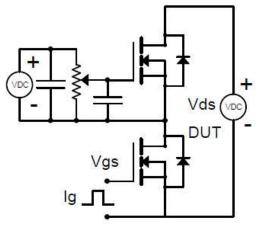


Fig.2-2 Gate charge waveform

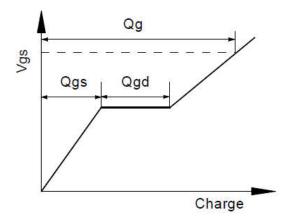


Fig.3-1 Avalanche test circuit

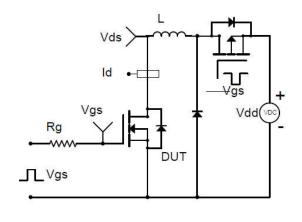
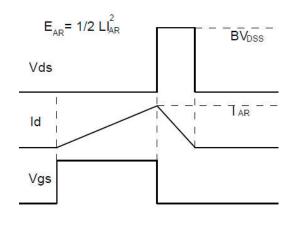


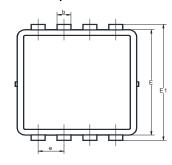
Fig.3-2 Avalanche waveform

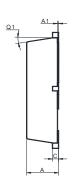


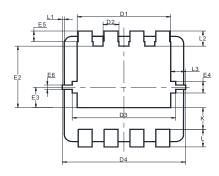


Package Outline Dimensions (Units: mm)

DFN3030



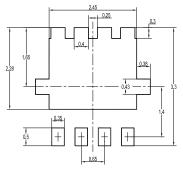




UNIT	Α	A1	b	С	D1	D2	D3	D4	Е	E1	E2	E3	E4
	0.9	0.05	0.35	0.25	2.6	0.5	2.7	3.2	3.1	3.3	1.85	0.68	0.43
mm	0.7	0	0.24	0.1	2.4	0.3	2.5	3	2.9	3.1	1.65	0.48	0.23

UNIT	E5	E6	е	K	L	L1	L2	L3	θ1
	0.4	0.25	0.7	0.72	0.5	0.1	0.53	0.475	12°
mm	0.2	0.15	0.6	0.52	0.3	0	0.33	0.275	0°

Recommended Soldering Footprint



Packing information

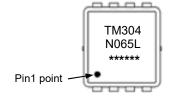
Dookogo	Tape Width	Tape Width Pitch		Reel	Size	Per Reel Packing	
Package	(mm)	mm	inch	mm	inch	Quantity	
DFN3030	12	8 ± 0.1	0.315 ± 0.004	330	13	5,000	

Marking information

" TM304N065L " = Part No.

" ***** " = Date Code Marking

Font type: Arial





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